6-1761614-0 ACTIVE

STEP-Z

TE Internal #: 6-1761614-0

PCB Mount Header, Vertical, Board-to-Board, 200 Position, 1.3 mm [.051 in] Centerline, Partially Shrouded, Gold, Surface Mount -

Solder Ball

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 200
Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	200
Number of Rows	2
Board-to-Board Configuration	Parallel

Electrical Characteristics

Dielectric Withstanding Voltage (Max)	500 VAC
Insulation Resistance	18 ΜΩ
Operating Voltage	48 VAC

Body Features

Contact Features



Contact Layout	Matrix
Mating Tab Width	1 mm[.04 in]
Mating Tab Thickness	.2 mm[.008 in]
Contact Shape & Form	Dual Beam, Single Beam, Square
PCB Contact Termination Area Plating Material	Tin-Silver
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[29.9212 μin]
Contact Type	Tab
Contact Current Rating (Max)	1 A
Termination Features	
Termination Method to Printed Circuit Board	Surface Mount - Solder Ball
Mechanical Attachment	
Mating Retention	With
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	
	1.3 mm[.051 in]
Housing Material	1.3 mm[.051 in] Thermoplastic
Housing Material	
Housing Material Dimensions	Thermoplastic
Housing Material Dimensions Connector Height	Thermoplastic 10.95 mm[.43 in]
Housing Material Dimensions Connector Height Row-to-Row Spacing	Thermoplastic 10.95 mm[.43 in] 2 mm[.079 in]
Housing Material Dimensions Connector Height Row-to-Row Spacing Stack Height	Thermoplastic 10.95 mm[.43 in] 2 mm[.079 in] 15 mm, 21 mm, 25 mm[.984 in]
Housing Material Dimensions Connector Height Row-to-Row Spacing Stack Height PCB Thickness (Recommended)	Thermoplastic 10.95 mm[.43 in] 2 mm[.079 in] 15 mm, 21 mm, 25 mm[.984 in]
Housing Material Dimensions Connector Height Row-to-Row Spacing Stack Height PCB Thickness (Recommended) Usage Conditions	Thermoplastic 10.95 mm[.43 in] 2 mm[.079 in] 15 mm, 21 mm, 25 mm[.984 in] 1.57 mm[.8 in]
Housing Material Dimensions Connector Height Row-to-Row Spacing Stack Height PCB Thickness (Recommended) Usage Conditions Operating Temperature Range	Thermoplastic 10.95 mm[.43 in] 2 mm[.079 in] 15 mm, 21 mm, 25 mm[.984 in] 1.57 mm[.8 in]
Housing Material Dimensions Connector Height Row-to-Row Spacing Stack Height PCB Thickness (Recommended) Usage Conditions Operating Temperature Range Operation/Application	Thermoplastic 10.95 mm[.43 in] 2 mm[.079 in] 15 mm, 21 mm, 25 mm[.984 in] 1.57 mm[.8 in] 0 – 100 °C[32 – 212 °F]



UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	25
Packaging Method	Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



















Customers Also Bought















Documents

Product Drawings

STEP-Z PLUG 10MM 200P LF ST

English

CAD Files

Customer View Model

ENG_CVM_CVM_6-1761614-0_B.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_6-1761614-0_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_6-1761614-0_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

PCB Mount Header, Vertical, Board-to-Board, 200 Position, 1.3 mm [.051 in] Centerline, Partially Shrouded, Gold, Surface Mount - Solder Ball



Datasheets & Catalog Pages

STEP-Z Interconnection System

English

Product Specifications

Application Specification

English